# TYS4020330M-10

### PHYSICAL DIMENSIONS:

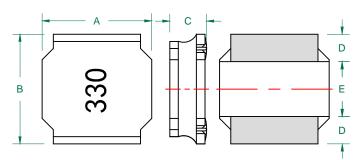
 $A 4.00 \pm 0.20$ 

 $B = 4.00 \pm 0.20$ 

C 2.00 MAX.

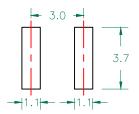
 $0.95 \pm 0.20$ 

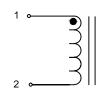
 $E 2.10 \pm 0.20$ 





### LAND PATTERNS FOR REFLOW SOLDERING



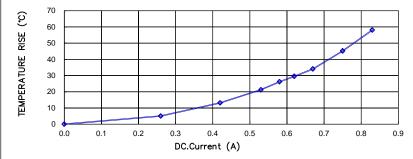




### **ELECTRICAL SPECIFICATION**

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 20%	26.4	33.0	39.6
DCR (Ω)		0.550	0.715

### CHARACTERISTICS OF TEMPERATURE RISE



## UNCONTROLLED DOCUMENT

Saturation Current(A)	0.85
SRF (MHz)	11
Temperature Rise Current (A)	0.49

NOTES: UNLESS OTHERWISE SPECIFIED

1.OPERATING TEMPERATURE RANGE: -40°C TO +125°C (INCLUDING SELF-HEATING) .

2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)

3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS: A. AMBIENT TEMPERATURE: 20±15°C.

B. RELATIVE HUMIDITY: 65%±20%.

4.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS ≤30% FROM ITS VALUE WITHOUT CURRENT.

5.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE (  $\Delta \text{T} \leq 40\,^{\circ}\text{C}$  ) FROM 20°C AMBIENT.

г		DIMENSIONS ARE IN mm .			The same of the same of the same	1			
F	DIMENSIONS ARE IN MM .			This print is the property of Laird Tech. and is loaned in confidence					
					subject to return upon request and	Laird			
Γ					with the understanding that no				
t					copies shall be made without the				J 💮
H					written consent of Laird Tech. All				
L					rights to design or invention are reserved.				
Г					PROJECT/PART NUMBER:	REV	PART TY		DRAWN BY:
H					TYS4020330M-10	В	PO		QIU
L						_	INDU	CTOR	4.0
	В	CHANGE LOGO	08/06/15	QIU	DATE: 09/06/12 SCA	LE: N	TS	SHEET:	
Γ	Α	ORIGINAL DRAFT	09/06/12	QIU	CAD #   TOO		13		
f	REV	DESCRIPTION	DATE	INT	TYS4020330M-10-B	٠,	-	1	of 1

# CURRENT VS INDUCTANCE DROP IN RATES 0% -5% -10% -15% -20% -25% 0.40 0.50 0.60 0.70 0.80 0.90 1.00 DC.Current(A)